

Day : Tuesday
 Date: 1/30/2007

Time: 12:23:59

PALM INTRANET**Inventor Name Search Result**

Your Search was:

Last Name = TAKANISHI

First Name = KEIJIRO

Application#	Patent#	Status	Date Filed	Title	Inventor Name
<u>07663958</u>	<u>5153183</u>	150	05/06/1991	METHYLENEDIPHOSPHONIC ACID COMPOUNDS AND METHODS OF USE FO THE TREATMENT OF RHEUMATISM AND OSTEOPOROSIS	TAKANISHI, KEIJIRO
<u>08256186</u>	<u>5565440</u>	150	06/28/1994	METHANE DIPHOSPHONIC ACID DERIVATIVE, ITS PRODUCTION PROCESS AND ITS PHARMACEUTICAL APPLICATIONS	TAKANISHI, KEIJIRO
<u>08555430</u>	<u>5679481</u>	150	11/09/1995	CATHODE MATERIAL, METHOD OF PREPARING IT AND NONAQUEOUS SOLVENT TYPE SECONDARY BATTERY HAVING A CATHODE COMPRISING IT	TAKANISHI, KEIJIRO
<u>08632421</u>	<u>5886206</u>	150	07/02/1996	PROCESS FOR PRODUCTION OF METHANEDIPHOSPHONIC ACID COMPOUND	TAKANISHI, KEIJIRO
<u>08936823</u>	Not Issued	161	09/25/1997	ELECTRODE FOR A BATTERY AND A BATTERY CONTAINING IT	TAKANISHI, KEIJIRO
<u>10130643</u>	<u>6750313</u>	150	05/20/2002	RESIN COMPOSITION AND ARTICLES MOLDED THEREFROM	TAKANISHI, KEIJIRO
<u>10514886</u>	Not Issued	30	11/17/2004	Resin, resin composition, process for production thereof, and moldings made by using the same	TAKANISHI, KEIJIRO
<u>10558275</u>	Not Issued	71	11/23/2004	Resin and article molded therefrom	TAKANISHI, KEIJIRO

Inventor Search Completed: No Records to Display.

Last Name

First Name

Search Another: Inventor

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Back to [PALM](#) | [ASSIGNMENT](#) | [OASIS](#) | [Home page](#)

Day : Tuesday
Date: 1/30/2007

Time: 12:24:35

PALM INTRANET**Inventor Name Search Result**

Your Search was:

Last Name = MATSUNO

First Name = TATSUYA

Application#	Patent#	Status	Date Filed	Title	Inventor Name
10514886	Not Issued	30	11/17/2004	Resin, resin composition, process for production thereof, and moldings made by using the same	MATSUNO, TATSUYA
10558275	Not Issued	71	11/23/2004	Resin and article molded therefrom	MATSUNO, TATSUYA

Inventor Search Completed: No Records to Display.

Search Another: Inventor**Last Name**

matsuno

First Name

Tatsuya

Search

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Back to [PALM](#) | [ASSIGNMENT](#) | [OASIS](#) | Home page

Day : Tuesday
Date: 1/30/2007

Time: 12:25:10

PALM INTRANET**Inventor Name Search Result**

Your Search was:

Last Name = KOHARA

First Name = TAKEHIRO

Application#	Patent#	Status	Date Filed	Title	Inventor Name
10558275	Not Issued	71	11/23/2004	Resin and article molded therefrom	KOHARA, TAKEHIRO
11609724	Not Issued	19	12/12/2006	ACRYLOYL MATERIALS FOR MOLDED PLASTICS	KOHARA, TAKEHIRO

Inventor Search Completed: No Records to Display.

Search Another: Inventor**Last Name**

Kohara

First Name

Takehiro

Search

To go back use Back button on your browser toolbar.

Back to [PALM](#) | [ASSIGNMENT](#) | [OASIS](#) | Home page

* * * * * STN Columbus * * * * *

FILE 'HOME' ENTERED AT 14:56:28 ON 30 JAN 2007

=> file pnttext
COST IN U.S. DOLLARS

SINCE FILE ENTRY	TOTAL SESSION
0.21	0.21

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FILE 'PATDPAFULL' ENTERED AT 14:56:50 ON 30 JAN 2007
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FILE 'PCTFULL' ENTERED AT 14:56:50 ON 30 JAN 2007
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FILE 'RDISCLOSURE' ENTERED AT 14:56:50 ON 30 JAN 2007
COPYRIGHT (C) 2007 Kenneth Mason Publications Ltd.

FILE 'USPATFULL' ENTERED AT 14:56:50 ON 30 JAN 2007
CA INDEXING COPYRIGHT (C) 2007 AMERICAN CHEMICAL SOCIETY (ACS)

FILE 'USPAT2' ENTERED AT 14:56:50 ON 30 JAN 2007
CA INDEXING COPYRIGHT (C) 2007 AMERICAN CHEMICAL SOCIETY (ACS)

=> s phosphonic acid and residue# and (divalent phenol residue# or dihydric phenol residue#)

L1 10 PHOSPHONIC ACID AND RESIDUE# AND (DIVALENT PHENOL RESIDUE# OR
DIHYDRIC PHENOL RESIDUE#)

=> s 11 and bicycloalkyl#
I:2 2 L1 AND BICYCLOALKYL#

=> d 12 1-2

L2 ANSWER 1 OF 2 EPFULL COPYRIGHT 2007 EPO/FIZ KA on STN

AN 2004:60209 EPFULL EDP 20050203 ED 20050203 UP 20050203
DUPD 20050202 DUPW 200505

TIEN RESIN AND ARTICLE MOLDED THEREFROM.

TIER RESINE ET ARTICLE MOULE AVEC CETTE RESINE.

TAKANISHI Keijiyo, 10-22-1504, Heso 3-chome, Ritto-shi, Shiga 5203031.

IN TARANISHI, KEIJIIC, 10-21-1961, HESSE & CHAMBERS, KELLOGG BLDG., BINGHAMTON,
TP:

MATSUNO, Tatsuya, 16-A2-33, Takehana Jizojiminamimachi, Yamashina-ku
Kyoto-shi, Kyoto 6078088, JP;
INOUE, Eiji, Toray Wakakusa-ryo 414 1-1, Oe 1-chome, Otsu-shi, Shiga

INOUE, EMI, Toray Wakakusa-ryo 414 1-1, Otsu 1-chome, Otsu-shi, Shiga
5202141, JP;
KOHARA, Takehiro, 10-A6-34, Sonoyama 2-chome, Otsu-shi, Shiga 5200842,
JP

PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku,
Tokyo 103-8666, JP

TOKYO
BAN 303533

PAN 20333
PT Patent

DT Patent
JAE Japanese

LAF Japanese
LA English

LAP English
TL English; French
PIT WOAI International application published with search report
PI WO 2004106413 A1 20041209
DS AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PL PT RO
SE SI SK TR
EXTENSION STATES: AL HR LT LV MK
AI EP 2004-745264 A 20040521
WO 2004-JP6953 A 20040521
PRAI JP 2003-148826 A 20030527
IC.VER 7
ICM C08G079-02
ICS G02B001-04

AN 2004:60209 EPFULL EDP 20050203 ED 20060329 UP 20060830
DUPD 20060830 DUPW 200635
TIEN RESIN AND ARTICLE MOLDED THEREFROM.
TIFR RESINE ET ARTICLE MOULE AVEC CETTE RESINE.
TIDE HARZ UND FORMKOeRPER DARAUS.
IN TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-shi, Shiga 5203031,
JP;
MATSUNO, Tatsuya, 16-A2-33, TakehanaJizojiminamimachi, Yamashina-ku,
Kyoto-shi, Kyoto 6078088, JP;
INOUE, Emi, Toray Wakakusa-ryo 4141-1, Oe 1-chome, Otsu-shi, Shiga
5202141, JP;
KOHARA, Takehiro, 10-A6-34, Sonoyama 2-chome, Otsu-shi, Shiga 5200842,
JP

PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku,
Tokyo 103-8666, JP
PAN 203533
AG Kador & Partner, Corneliusstrasse 15, 80469 Muenchen, DE
AGN 100212
DT Patent
LAF Japanese
LA English
LAP English
TL German; English; French
PIT EPA1 Application published with search report
PI EP 1640405 A1 20060329
WO 2004106413 20041209
DS AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PL PT RO
SE SI SK TR
AI EP 2004-745264 A 20040521
WO 2004-JP6953 A 20040521
PRAI JP 2003-148826 A 20030527
IPCI C08G0079-02 [I,A]; G02B0001-04 [I,A]
C08G0079-00 [I,C*]; G02B0001-04 [I,C*]

L2 ANSWER 2 OF 2 USPATFULL on STN
AN 2006:334849 USPATFULL
TI Resin and article molded therefrom
IN Takanishi, Keijiro, 10-22-1504, HESO 3-CHOME, RITTO-SHI, SHIGA, JAPAN
520-3031
Matsuno, Tatsuya, Kyoto, JAPAN
Inoue, Emi, Shiga, JAPAN
Kohara, Takehiro, Shiga, JAPAN
PI US 2006287464 A1 20061221
AI US 2004-558275 A1 20040521 (10)
WO 2004-JP6953 20040521
20041123 PCT 371 date
PRAI JP 2003-148826 20030527
DT Utility
FS APPLICATION
LN.CNT 847

INCL INCLM: 528/086.000
INCLS: 528/398.000
NCL NCLM: 528/086.000
NCLS: 528/398.000
IC IPCI C08G0061-02 [I,A]; C08G0061-00 [I,C*]; C08G0079-02 [I,A];
C08G0079-00 [I,C*]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

=> d 11 1-10

L1 ANSWER 1 OF 10 EPFULL COPYRIGHT 2007 EPO/FIZ KA on STN

AN 2004:60209 EPFULL EDP 20050203 ED 20050203 UP 20050203
DUPD 20050202 DUPW 200505
TIEN RESIN AND ARTICLE MOLDED THEREFROM.
TIFR RESINE ET ARTICLE MOULE AVEC CETTE RESINE.
IN TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-shi, Shiga 5203031,
JP;
MATSUNO, Tatsuya, 16-A2-33, Takehana Jizojiminamimachi, Yamashina-ku,
Kyoto-shi, Kyoto 6078088, JP;
INOUE, Emi, Toray Wakakusa-ryo 414 1-1, Oe 1-chome, Otsu-shi, Shiga
5202141, JP;
KOHARA, Takehiro, 10-A6-34, Sonoyama 2-chome, Otsu-shi, Shiga 5200842,
JP
PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku,
Tokyo 103-8666, JP
PAN 203533
DT Patent
LAF Japanese
LA English
LAP English
TL English; French
PIT WOA1 International application published with search report
PI WO 2004106413 A1 20041209
DS AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PL PT RO
SE SI SK TR
EXTENSION STATES: AL HR LT LV MK
AI EP 2004-745264 A 20040521
WO 2004-JP6953 A 20040521
PRAI JP 2003-148826 A 20030527
IC.VER 7
ICM C08G079-02
ICS G02B001-04

AN 2004:60209 EPFULL EDP 20050203 ED 20060329 UP 20060830
DUPD 20060830 DUPW 200635
TIEN RESIN AND ARTICLE MOLDED THEREFROM.
TIFR RESINE ET ARTICLE MOULE AVEC CETTE RESINE.
TIDE HARZ UND FORMKOeRPER DARAUS.
IN TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-shi, Shiga 5203031,
JP;
MATSUNO, Tatsuya, 16-A2-33, Takehana Jizojiminamimachi, Yamashina-ku,
Kyoto-shi, Kyoto 6078088, JP;
INOUE, Emi, Toray Wakakusa-ryo 4141-1, Oe 1-chome, Otsu-shi, Shiga
5202141, JP;
KOHARA, Takehiro, 10-A6-34, Sonoyama 2-chome, Otsu-shi, Shiga 5200842,
JP
PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku,
Tokyo 103-8666, JP
PAN 203533
AG Kador & Partner, Corneliusstrasse 15, 80469 Muenchen, DE
AGN 100212
DT Patent

LAF Japanese
LA English
LAP English
TL German; English; French
PIT EPA1 Application published with search report
PI EP 1640405 A1 20060329
WO 2004106413 20041209
DS AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PL PT RO
SE SI SK TR
AI EP 2004-745264 A 20040521
WO 2004-JP6953 A 20040521
PRAI JP 2003-148826 A 20030527
IPCI C08G0079-02 [I,A]; G02B0001-04 [I,A]
C08G0079-00 [I,C*]; G02B0001-04 [I,C*]

L1 ANSWER 2 OF 10 EPFULL COPYRIGHT 2007 EPO/FIZ KA on STN

AN 2003:53662 EPFULL
DUPD 20040121 DUPW 200404

TIEN RESIN, RESIN COMPOSITIONS, PROCESS FOR PRODUCTION THEREOF, AND MOLDINGS MADE BY USING THE SAME.

TIFR RESINE, COMPOSITIONS DE RESINE, PROCEDE DE PRODUCTION ASSOCIE ET MOULAGES CORRESPONDANTS.

IN MATSUNO, Tatsuya, 16-A2-33, Takehana Jizojiminamimachi, Yamashina-ku, Kyoto-shi, Kyoto 607-8088, JP;
TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-shi, Shiga 520-3031, JP

PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku, Tokyo 103-8666, JP

PAN 203533
DT Patent
LAF Japanese
LA English
LAP English
TL English; French
PIT WOA1 International application published with search report
PI WO 2003097720 A1 20031127

DS AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL
EXTENSION STATES: AL LT LV MK

AI EP 2003-721105 A 20030513
WO 2003-JP5946 A 20030513

PRAI JP 2002-144184 A 20020520

IC.VER 7
ICM C08G079-02
ICS C08L085-02; G02B001-04

AN 2003:53662 EPFULL ED 20050330 UP 20050907
DUPD 20050907 DUPW 200536

TIEN RESIN, RESIN COMPOSITIONS, PROCESS FOR PRODUCTION THEREOF, AND MOLDINGS MADE BY USING THE SAME.

TIFR RESINE, COMPOSITIONS DE RESINE, PROCEDE DE PRODUCTION ASSOCIE ET MOULAGES CORRESPONDANTS.

TIDE HARZ, HARZZUSAMMENSETZUNGEN, HERSTELLUNGSVERFAHREN DAFUEr UND DAMIT HERGESTELLTE FORMKOeRPER.

IN MATSUNO, Tatsuya, 16-A2-33, Takehana Jizojiminamimachi, Yamashina-ku, Kyoto-shi, Kyoto 607-8088, JP;
TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-shi, Shiga 520-3031, JP

PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku, Tokyo 103-8666, JP

PAN 203533
AG Kador & Partner, Corneliusstrasse 15, 80469 Muenchen, DE
AGN 100211
DT Patent

LAF Japanese
LA English
LAP English
TL German; English; French
PIT EPA1 Application published with search report
PI EP 1518884 A1 20050330
WO 2003097720 20031127
DS DE FR GB
AI EP 2003-721105 A 20030513
WO 2003-JP5946 A 20030513
PRAI JP 2002-144184 A 20020520
IC.VER 7
ICM C08G079-02
ICS C08L085-02; G02B001-04

L1 ANSWER 3 OF 10 EPFULL COPYRIGHT 2007 EPO/FIZ KA on STN

AN 2001:117271 EPFULL
DUPD 20021016 DUPW 200242
TIEN RESIN COMPOSITION AND ARTICLES MOLDED THEREFROM.
TIFR COMPOSITION DE RESINE ET ARTICLES MOULES A PARTIR DE CELLE-CI.
TIDE HARZZUSAMMENSETZUNG UND DARAUS GEFORMTE ARTIKEL.
IN TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-cho, Kurita-gun,
Shiga 520-3031, JP;
KUMAGAI, Takuya, Toray Mishima-ryo F532, 12-6, Bunkyo-cho 2-chome,
Mishima-shi, Shizuoka 411-0033, JP;
ISHINABE, Ryouichi, Seien-ryo 111, 15-1, Sonoyama 2-chome, Otsu-shi,
Shiga 520-0842, JP
PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku,
Tokyo 103-8666, JP
PAN 203533
AG Kador & Partner, Corneliusstrasse 15, 80469 Muenchen, DE
AGN 100211
DT Patent
LAF Japanese
LA English
LAP English
TL German; English; French
PIT WO1 International application published with search report
PI WO 2002024787 A1 20020328
DS AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR
AI EP 2001-963472 A 20010906
WO 2001-JP7735 A 20010906
PRAI JP 2000-288254 A 20000922
IC.VER 7
ICM C08G079-02
ICS C08G064-08; C08J005-00; G02B001-04; G02B005-30

AN 2001:117271 EPFULL
DUPD 20031203 DUPW 200349
TIEN RESIN COMPOSITION AND ARTICLES MOLDED THEREFROM.
TIFR COMPOSITION DE RESINE ET ARTICLES MOULES A PARTIR DE CELLE-CI.
TIDE HARZZUSAMMENSETZUNG UND DARAUS GEFORMTE ARTIKEL.
IN TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-cho, Kurita-gun,
Shiga 520-3031, JP;
KUMAGAI, Takuya, 503-1-302, Yatamikado, Mishima-shi, Shizuoka 411-0801,
JP;
ISHINABE, Ryouichi, Seien-ryo 111, 15-1, Sonoyama 2-chome, Otsu-shi,
Shiga 520-0842, JP
PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku,
Tokyo 103-8666, JP
PAN 203533
AG Kador & Partner, Corneliusstrasse 15, 80469 Muenchen, DE
AGN 100211

DT Patent
 LAF Japanese
 LA English
 LAP English
 TL German; English; French
 PIT EPA1 Application published with search report
 PI EP 1270646 A1 20030102
 WO 2002024787 20020328
 DS AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR
 AI EP 2001-963472 A 20010906
 WO 2001-JP7735 A 20010906
 PRAI JP 2000-288254 A 20000922
 IC.VER 7
 ICM C08G079-02
 ICS C08G064-08; C08J005-00; G02B001-04; G02B005-30

 L1 ANSWER 4 OF 10 PCTFULL COPYRIGHT 2007 Univentio on STN
 AN 2002024787 PCTFULL ED 20020701 EW 200213
 TIEN RESIN COMPOSITION AND ARTICLES MOLDED THEREFROM
 TIFR COMPOSITION DE RESINE ET ARTICLES MOULES A PARTIR DE CELLE-CI
 IN TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-cho, Kurita-gun,
 Shiga 520-3031, JP [JP, JP];
 KUMAGAI, Takuya, Toray Mishima-ryo F532, 12-6, Bunkyo-cho 2-chome,
 Mishima-shi, Shizuoka 411-0033, JP [JP, JP];
 ISHINABE, Ryouichi, Seien-ryo 111, 15-1, Sonoyama 2-chome, Otsu-shi,
 Shiga 520-0842, JP [JP, JP]
 PA TORAY INDUSTRIES, INC., 2-1, Nihonbashi Muromachi 2-chome, Chuo-ku,
 Tokyo 103-8666, JP [JP, JP], for all designates States except US;
 TAKANISHI, Keijiro, 10-22-1504, Heso 3-chome, Ritto-cho, Kurita-gun,
 Shiga 520-3031, JP [JP, JP], for US only;
 KUMAGAI, Takuya, Toray Mishima-ryo F532, 12-6, Bunkyo-cho 2-chome,
 Mishima-shi, Shizuoka 411-0033, JP [JP, JP], for US only;
 ISHINABE, Ryouichi, Seien-ryo 111, 15-1, Sonoyama 2-chome, Otsu-shi,
 Shiga 520-0842, JP [JP, JP], for US only
 AG SATO, Kenji, c/o Shiga Branch, TORAY INTELLECTUAL PROPERTY EXPERTS CO.,
 LTD., 1-1, Sonoyama 1-chome, Otsu-shi, Shiga 520-8558, JP
 LAF Japanese
 LA Japanese
 DT Patent
 PI WO 2002024787 A1 20020328
 DS W: KR US
 RW (EPO): AT BE CH CY DE DK ES FI FR GB GR IE IT LU MC NL PT SE TR
 PRAI JP 2000-2000-288254 20000922
 AI WO 2001-JP7735 A 20010906
 ICM C08G079-02
 ICS C08G064-08; C08J005-00; G02B001-04; G02B005-30

 L1 ANSWER 5 OF 10 USPATFULL on STN
 AN 2006:334849 USPATFULL
 TI Resin and article molded therefrom
 IN Takanishi, Keijiro, 10-22-1504, HESO 3-CHOME, RITTO-SHI, SHIGA, JAPAN
 520-3031
 Matsuno, Tatsuya, Kyoto, JAPAN
 Inoue, Emi, Shiga, JAPAN
 Kohara, Takehiro, Shiga, JAPAN
 PI US 2006287464 A1 20061221
 AI US 2004-558275 A1 20040521 (10)
 WO 2004-JP6953 20040521
 20041123 PCT 371 date
 PRAI JP 2003-148826 20030527
 DT Utility
 FS APPLICATION
 LN.CNT 847
 INCL INCLM: 528/086.000

NCL INCLS: 528/398.000
NCLM: 528/086.000
NCLS: 528/398.000
IC IPCI C08G0061-02 [I,A]; C08G0061-00 [I,C*]; C08G0079-02 [I,A];
C08G0079-00 [I,C*]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L1 ANSWER 6 OF 10 USPATFULL on STN
AN 2006:54799 USPATFULL
TI Resin, resin composition, process for production thereof, and moldings made by using the same
IN Matsuno, Tatsuya, Kyoto-shi, Kyoto, JAPAN
Takanishi, Keijiro, Ritto-shi, Shiga, JAPAN
PI US 2006047104 A1 20060302
AI US 2003-514886 A1 20030513 (10)
WO 2003-JP5946 20030513
20041117 PCT 371 date
PRAI JP 2002-144184 20020520
DT Utility
FS APPLICATION
LN.CNT 1333
INCL INCLM: 528/377.000
NCL NCLM: 528/377.000
IC IPCI C08G0075-32 [I,A]; C08G0075-00 [I,C*]
IPCR C08G0075-00 [I,C]; C08G0075-32 [I,A]; C08G0079-00 [I,C*];
C08G0079-02 [I,A]; C08L0085-00 [I,C*]; C08L0085-02 [I,A];
G02B0001-04 [I,C*]; G02B0001-04 [I,A]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L1 ANSWER 7 OF 10 USPATFULL on STN
AN 2003:18079 USPATFULL
TI Resin composition and articles molded therefrom
IN Takanishi, Keijiro, Shiga, JAPAN
Kumagai, Takuya, Shizuoka, JAPAN
Ishinabe, Ryouichi, Shiga, JAPAN
PI US 2003013836 A1 20030116
US 6750313 B2 20040615
AI US 2002-130643 A1 20020520 (10)
WO 2001-JP7735 20010906
PRAI JP 2000-288254 20000922
DT Utility
FS APPLICATION
LN.CNT 943
INCL INCLM: 528/086.000
INCLS: 528/106.000; 528/108.000
NCL NCLM: 528/196.000; 528/086.000
NCLS: 264/176.100; 264/219.000; 359/642.000; 428/411.100; 428/412.000;
528/198.000; 528/106.000; 528/108.000
IC [7]
ICM C08G065-40
IPCI C08G0065-40 [ICM,7]; C08G0065-00 [ICM,7,C*]
IPCI-2 C08G0064-00 [ICM,7]
IPCR C08G0064-00 [I,C*]; C08G0064-08 [I,A]; C08G0079-00 [I,C*];
C08G0079-04 [I,A]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L1 ANSWER 8 OF 10 USPATFULL on STN
AN 94:51503 USPATFULL
TI Process for preparing random copolycarbonate
IN Marks, Maurice J., Lake Jackson, TX, United States
Ho, Thoi H., Lake Jackson, TX, United States
PA The Dow Chemical Company, Midland, MI, United States (U.S. corporation)
PI US 5321116 19940614
AI US 1993-43125 19930405 (8)

RLI Division of Ser. No. US 1991-730327, filed on 15 Jul 1991, now patented,
Pat. No. US 5212282
DT Utility
FS Granted
LN.CNT 700
INCL INCLM: 528/204.000
INCLS: 528/125.000; 528/126.000; 528/171.000; 528/174.000; 528/196.000;
528/198.000; 528/201.000; 528/202.000
NCL NCLM: 528/204.000
NCLS: 528/125.000; 528/126.000; 528/171.000; 528/174.000; 528/196.000;
528/198.000; 528/201.000; 528/202.000
IC [5]
ICM C08G064-20
IPCI C08G0064-20 [ICM,5]; C08G0064-00 [ICM,5,C*]
IPCR C08G0064-00 [I,C*]; C08G0064-06 [I,A]; C08G0064-20 [I,A]
EXF 528/204; 528/125; 528/126; 528/171; 528/174; 528/196; 528/198; 528/201;
528/202
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L1 ANSWER 9 OF 10 USPATFULL on STN
AN 93:40105 USPATFULL
TI Process for preparing random copolycarbonate from dianion of
ortho-substituted dihydric phenol
IN Marks, Maurice J., Lake Jackson, TX, United States
Ho, Thoi H., Lake Jackson, TX, United States
PA The Dow Chemical Company, Midland, MI, United States (U.S. corporation)
PI US 5212282 19930518
AI US 1991-730327 19910715 (7)
DT Utility
FS Granted
LN.CNT 659
INCL INCLM: 528/204.000
INCLS: 528/125.000; 528/126.000; 528/171.000; 528/174.000; 528/196.000;
528/198.000; 528/201.000; 528/202.000
NCL NCLM: 528/204.000
NCLS: 528/125.000; 528/126.000; 528/171.000; 528/174.000; 528/196.000;
528/198.000; 528/201.000; 528/202.000
IC [5]
ICM C08G064-20
IPCI C08G0064-20 [ICM,5]; C08G0064-00 [ICM,5,C*]
IPCR C08G0064-00 [I,C*]; C08G0064-06 [I,A]; C08G0064-20 [I,A]
EXF 528/204; 528/199; 528/196; 528/201; 528/202; 528/171; 528/174; 528/125;
528/126
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L1 ANSWER 10 OF 10 USPAT2 on STN
AN 2003:18079 USPAT2
TI Resin composition and articles molded therefrom
IN Takanishi, Keijiro, Shiga, JAPAN
Kumagai, Takuuya, Shizuoka, JAPAN
Ishinabe, Ryouichi, Shiga, JAPAN
PA Toray Industries, Inc., JAPAN (non-U.S. corporation)
PI US 6750313 B2 20040615
WO 2002024787 20020328
AI US 2002-130643 20020520 (10)
WO 2001-JP7735 20010906
PRAI JP 2000-288254 20000922
DT Utility
FS GRANTED
LN.CNT 947
INCL INCLM: 528/196.000
INCLS: 264/176.100; 264/219.000; 359/642.000; 428/411.100; 428/412.000;
528/198.000
NCL NCLM: 528/196.000; 528/086.000

NCLS: 264/176.100; 264/219.000; 359/642.000; 428/411.100; 428/412.000;
528/198.000; 528/106.000; 528/108.000

IC [7]

ICM C08G064-00

IPCI C08G0065-40 [ICM,7]; C08G0065-00 [ICM,7,C*]

IPCI-2 C08G0064-00 [ICM,7]

IPCR C08G0064-00 [I,C*]; C08G0064-08 [I,A]; C08G0079-00 [I,C*];
C08G0079-04 [I,A]

EXF 528/196; 528/198; 359/642; 428/411; 428/411.1; 428/412; 264/176.1;
264/219

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

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